

PHOTOCOUPLER **PS2513-1,PS2513L-1**

HIGH-SPEED SWITCHING/HIGH ISOLATION VOLTAGE PHOTOCOUPLER SERIES -NEPOC Series-

DESCRIPTION

The PS2513-1 and PS2513L-1 are optically coupled isolators containing a GaAs light emitting diode and an NPN silicon phototransistor.

The PS2513-1 is in a plastic DIP (Dual In-line Package) and the PS2513L-1 is lead bending type (Gull-wing) for surface mount.

FEATURES

- High isolation voltage (BV = 5 000 Vr.m.s.)
- High collector to emitter voltage (VcEo = 120 V)
- Guaranteed maximum switching speed (toff ≤ 60 μs @ IF = 5 mA, Vcc = 5 V, RL = 1.9 kΩ)
- High-speed switching (ton = 5 μ s TYP. @ IF = 5 mA, Vcc = 5 V, RL = 1.9 k Ω)

(toff = 25
$$\mu$$
s TYP. @ IF = 5 mA, Vcc = 5 V, RL = 1.9 k Ω)

- Ordering number of tape product: PS2513L-1-E3, E4, F3, F4
- ★ Safety standards
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

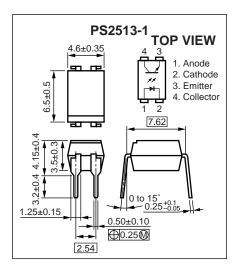
APPLICATIONS

- · Power supply
- · Air conditioner
- FA equipment

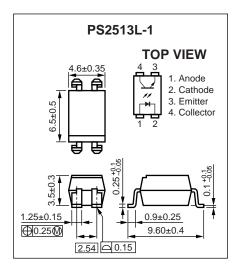
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PACKAGE DIMENSIONS (UNIT: mm)

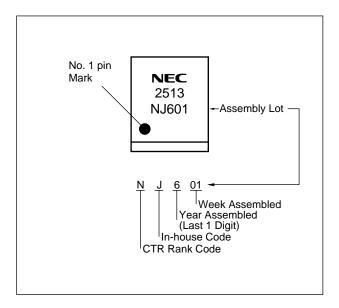
DIP Type



Lead Bneding Type



★ MARKING EXAMPLE



★ ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS2513-1	PS2513-1-A	Pb-Free	Magazine case 100 pcs	Standard products	PS2513-1
PS2513L-1	PS2513L-1-A			(UL Approved)	
PS2513L-1-E3	PS2513L-1-E3-A		Embossed Tape 1 000 pcs/reel		
PS2513L-1-E4	PS2513L-1-E4-A				
PS2513L-1-F3	PS2513L-1-F3-A		Embossed Tape 2 000 pcs/reel		
PS2513L-1-F4	PS2513L-1-F4-A				
PS2513-1-V	PS2513-1-V-A		Magazine case 100 pcs	DIN EN60747-5-2	
PS2513L-1-V	PS2513L-1-V-A			(VDE0884 Part2)	
PS2513L-1-V-E3	PS2513L-1-V-E3-A		Embossed Tape 1 000 pcs/reel	approved products	
PS2513L-1-V-E4	PS2513L-1-V-E4-A			(Option)	
PS2513L-1-V-F3	PS2513L-1-V-F3-A		Embossed Tape 2 000 pcs/reel		
PS2513L-1-V-F4	PS2513L-1-V-F4-A				

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings PS2513-1, PS2513L-1	Unit
Diode	Reverse Voltage	VR	6	V
	Forward Current (DC)	lF	60	mA
	Power Dissipation Derating	⊿P₀/°C	1.5	mW/°C
	Power Dissipation	Po	150	mW
	Peak Forward Current*1	IFP	1	Α
Transistor	Collector to Emitter Voltage	Vceo	120	٧
	Emitter to Collector Voltage	VECO	6	٧
	Collector Current	lc	30	mA
	Power Dissipation Derating	⊿Pc/°C	1.5	mW/°C
	Power Dissipation	Pc	150	mW
Isolation Voltage*2		BV	5 000	Vr.m.s.
Operating Ambient Temperature		TA	-55 to +100	°C
Storage Temperature		T _{stg}	-55 to +150	°C

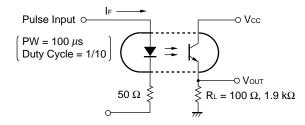
^{*1} PW = 100 μ s, Duty Cycle = 1%

^{*2} AC voltage for 1 minute at $T_A = 25$ °C, RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together.

ELECTRICAL CHARACTERISTICS (TA = 25°C)

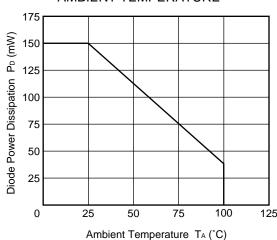
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	I _F = 5 mA		1.1	1.3	V
	Reverse Current	lR	VR = 5 V			5	μА
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		30		pF
Transistor	Collector to Emitter Dark Current	ICEO	VcE = 120 V, IF = 0 mA			100	nA
Coupled	Current Transfer Ratio	CTR1	IF = 1 mA, VcE = 5 V	25	75	100	%
	(Ic/IF)	CTR2	IF = 5 mA, VCE = 5 V	50	125	200	%
	Collector Saturation Voltage	VCE(sat)	IF = 10 mA, Ic = 2 mA			0.3	V
	Isolation Resistance	Ri-o	Vi-o = 1.0 kVpc	10 ¹¹			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1.0 MHz		0.5		pF
	Rise Time*1	tr	$Vcc = 5 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ RL} = 100 \Omega$		3		μs
	Fall Time*1	t _f			4		
	Turn-on Time ^{*1}	ton	$Vcc = 5 \text{ V}, \text{ If } = 5 \text{ mA}, \text{ RL} = 1.9 \text{ k}\Omega$		5	60	μs
	Turn-off Time*1	toff			25	60	

*1 Test circuit for switching time

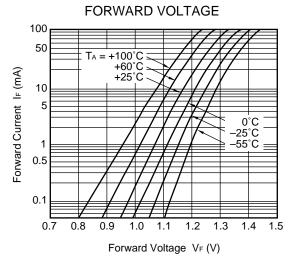


TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

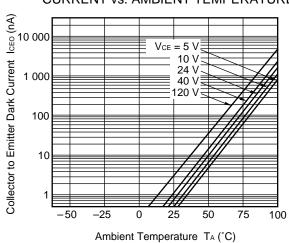




FORWARD CURRENT vs.

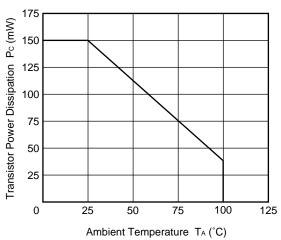


COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE

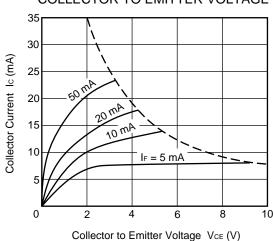


Remark The graphs indicate nominal characteristics.

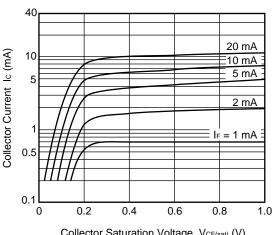
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



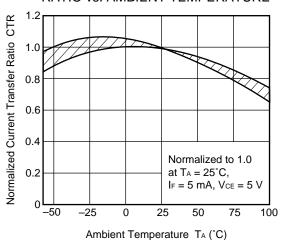
COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



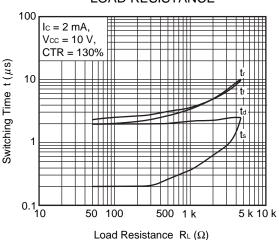
COLLECTOR CURRENT vs. **COLLECTOR SATURATION VOLTAGE**



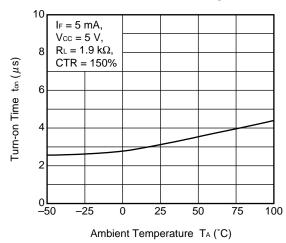
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



SWITCHING TIME vs. LOAD RESISTANCE

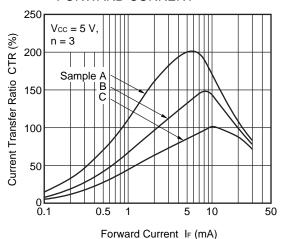


TURN-ON TIME vs. AMBIENT TEMPERATURE

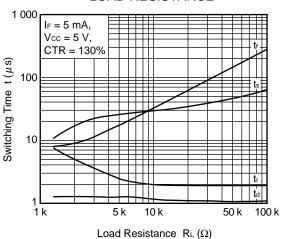


Remark The graphs indicate nominal characteristics.

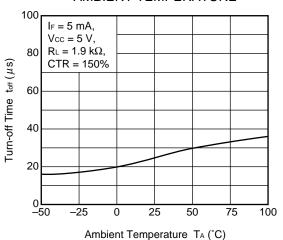
CURRENT TRANSFER RATIO vs. FORWARD CURRENT

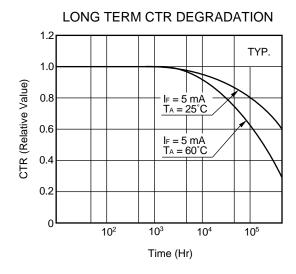


SWITCHING TIME vs. LOAD RESISTANCE



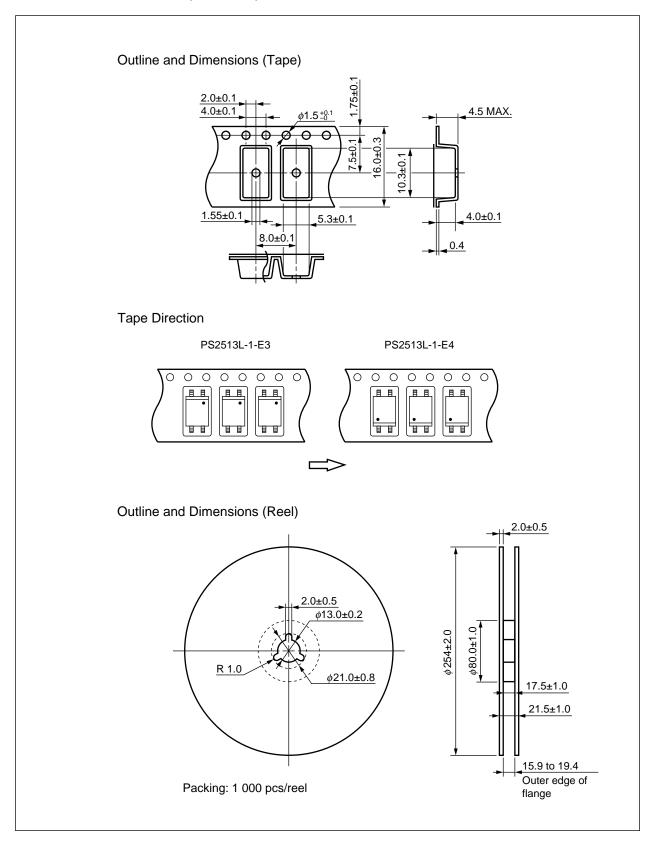
TURN-OFF TIME vs.
AMBIENT TEMPERATURE

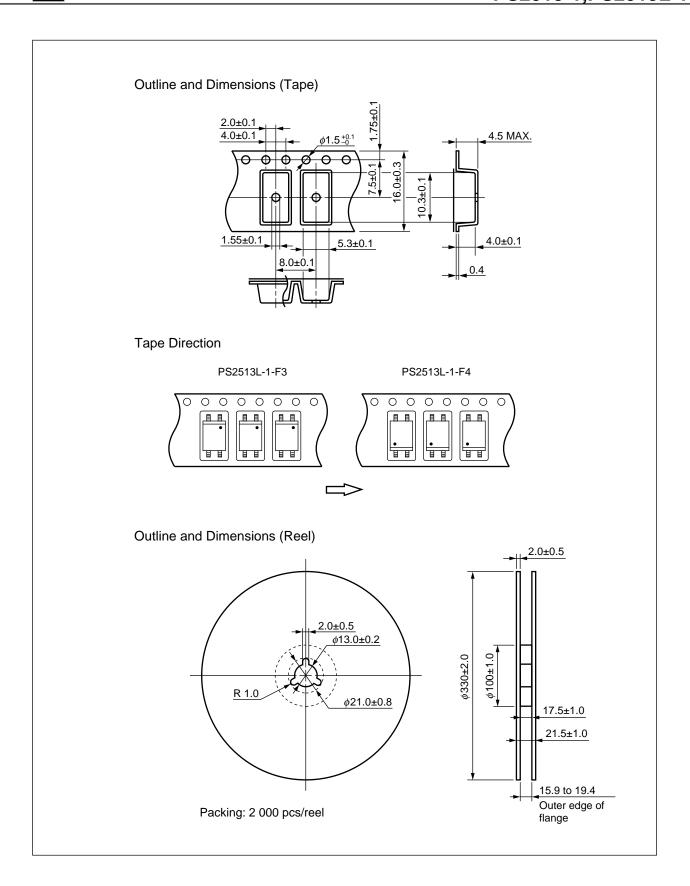




Remark The graph indicates nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)





NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

Peak reflow temperature
 260°C or below (package surface temperature)

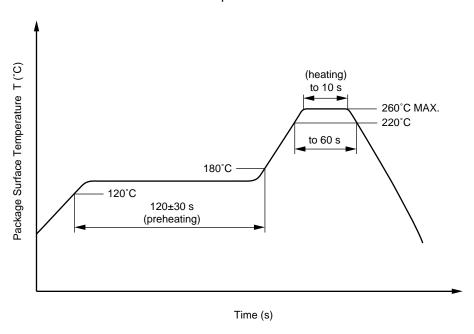
Time of peak reflow temperature
 Time of temperature higher than 220°C
 60 seconds or less

Time to preheat temperature from 120 to 180°C 120±30 s
 Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120°C or below (package surface temperature)

• Number of times One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

★ (3) Soldering by soldering iron

Peak temperature (lead part temperature) 350°C or below
 Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

★ 3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

★ SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Speck	Unit
Application classification (DIN VDE 0109) for rated line voltages \leq 300 Vr.m.s. for rated line voltages \leq 600 Vr.m.s.		IV III	
Climatic test class (DIN IEC 68 Teil 1/09.80)		55/100/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.2 \times U_{\text{IORM}}, P_{\text{d}} < 5 \text{pC}$	Ulorm Upr	890 1 068	V _{peak} V _{peak}
Test voltage (partial discharge test, procedure b for all devices test) $U_{pr} = 1.6 \times U_{IORM}, \ P_d < 5 \ pC$	Upr	1 424	V_{peak}
Highest permissible overvoltage	UTR	8 000	V _{peak}
Degree of pollution (DIN VDE 0109)		2	
Clearance distance		> 7.0	mm
Creepage distance		> 7.0	mm
Comparative tracking index (DIN IEC 112/VDE 0303 part 1)	СТІ	175	
Material group (DIN VDE 0109)		III a	
Storage temperature range	Tstg	-55 to +150	°C
Operating temperature range	TA	-55 to +100	°C
Isolation resistance, minimum value VIO = 500 V dc at TA = 25 °C VIO = 500 V dc at TA MAX. at least 100 °C	Ris MIN. Ris MIN.	10 ¹² 10 ¹¹	Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature	Tsi	175	°C
Current (input current I _F , Psi = 0) Power (output or total power dissipation) Isolation resistance	Isi Psi	400 700	mA mW
V _{IO} = 500 V dc at T _A = 175 °C (Tsi)	Ris MIN.	10 ⁹	Ω

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M8E 00.4-0110

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
 - 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

▶For further information, please contact

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